As a below named inventor, I hereby declare that:

including the claims, as amended by any amendment referred to above.

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for

I DETTERG I WILL OTIZITION, TITLE WING DOTO THEOREMS (TT OHIS) AND HOME TO THE WALL TO	
first and joint inventor (if plural names are listed below) of the subject matter which	
which a patent is sought on the invention entitled MILK FLOW METER FOR A MILKING SYSTEM	HAVING A
SUBSTANTIALLY STABLE VACUUM LEVEL AND METHOD FOR USING SAME the specification of which:	
(check one) [X] is attached hereto.	
[] was filed on	as
Application Serial No.	and
was amended on	_(if applicable).
I hereby state that I have reviewed and understand the contents of the above-identified	specification,

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent of inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)			Priority	Claimed
with the control of t	NONE		Yes	No
(Number)	(Country)	(Day/Month/Year Filed)		
Emirates -			Yes	No
(Number)	(Country)	(Day/Month/Year Filed)		
Market 4	· · · · · · · · · · · · · · · · · · ·	_	Yes	ИО
(Number)	(Country)	(Day/Month/Year Filed)		

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States code § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

	м/м	
(Application Serial No.)	(Filing Date)	(Status-patented, pending, abandoned)
(Application Serial No.)	(Filing Date)	(Status-patented, pending, abandoned)

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

all business in the Patent and Trademark Office connected therewith:

Daniel J. Meaney, Jr., Req. 22179

Address all telephone calls to Daniel J. Meaney, Jr., at telephone no. (805)687-6909

Address all correspondence to Daniel J. Meaney, Jr., Esq.

P. O. Box 22307

Santa Barbara, California 93121

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief and are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of first joint inventor Stan A. Brown	
Inventor's signatureAA	Date February 42001
Residence: <u>Hanford</u> , <u>California</u>	Citizenship USA

Post Office Address 2144 Chardonnay, Hanford, California 93230

Full Name of second joint inventor, Af any Rafael Antonio Fematt	
Inventor's signature	Date February 2001
Full Name of second joint inventor, if any Rafael Antonio Fematt  Inventor's signature	Citizenship <u>Mexico</u>
Post Office Address Pasaje la Capilla 133, Res. La Haciend, Torreor	n, Coahuila, 27250 Mexico

is a below named inventor, I hereby declare that:

1.

My residence, post office address and citizenship are as stated below next to my name.

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[] was filed					as
	Serial No.				and
was amended	on				(if applicable).
I hereby state that I have	reviewed and under	rstand the conten	ts of the above	e-identified	specification,
including the claims, as an	mended by any amend	dment referred to	above.		
I acknowledge the duty to d				mination of	this application in
accordance with Title 37, 0	ode or rederat keć	guracions, 3 1.36	(a).		
I hereby claim foreign price	ority benefits unde	er Title 35. Unit	ed States Code	. § 119 of a	nv foreign
application(s) for patent of	_				_
foreign application for pat					
application on which priori					
Prior Foreign Application(s				Priority	
· · · · · · · · · · · · · · · · · · ·	NONE	/D /20 4 2 /27	727 - 31	Yes	No
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listed below and, insofar a in the prior United States States code § 112, I acknown of Federal Regulations, § 1 national or PCT internation	application in the owledge the duty to 1.56(a) which occur	e manner provided o disclose materi rred between the	by the first plant and information filing date of	paragraph of as defined	Title 35, United in Title 37, Code
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I hereby appoint the followall business in the Patent Daniel J. Meaney, Jr., Re	and Trademark Off:			s applicatio	on and to transact
Address all telephone calls		ney, Jr.,	at telephone n	o. <u>(805)687</u>	-6909
Address all correspondence					
_	P. O. Box 2230	07			
		, California 9312			
I hereby declare that all :					
on information and belief					
the knowledge that willful					
or both, under Section 100					. false statements
may jeopardize the validity	y of the application	on or any patent	issued thereon	•	
m 33	was Dahamb C '	Danahamta			
Full name of third joint in	nventor Robert C.	Borchery	Date Februar	v 12/ 2001	
Third Inventor's signature Residence: Rio Rancho, New	•	W W IN W U		ship <u>USA</u>	
Post Office Address 200 In		Rancho. New Mexi	<del></del>		
TOOL OTTION FINANCED TO THE			· · · · · · · · · · · · · · · · · · ·		
Full Name of fourth joint :	inventor, if any V	ictor Manuel Vies	sca		
Fourth Inventor's signature			Date	February /2	2001

Citizenship

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Fourth Inventor's signature

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